

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:)
Haruaki SUE et al.) Atty. Docket No.: **TM&K 0014**
Serial No. _____ (continuation of)
U.S. Serial No. 09/319,487 filed)
August 13, 1999))
Filed: Herewith)
For: CYCLOPENTYLENE COMPOUND)
AND INTERMEDIATE THEREOF.)
EPOXY RESIN COMPOSITION.)
MOLDING MATERIAL, AND)
RESIN-ENCAPSULATED) Date: November 9, 2001
ELECTRONIC DEVICE)



INFORMATION DISCLOSURE STATEMENT

BOX: CON PATENT APPLICATION

Assistant Commissioner for Patents
Washington, D. C. 20231

Sir:

This is an Information Disclosure Statement with regard to the above-identified application. Forms PTO/SB/08A&B are attached.

Copies of the cited documents can be found in the applicant's parent U. S. Patent Application Serial No. 09/319,487. Accordingly, no further comment in regard to the disclosures of these documents is believed to be required.

It is respectfully requested that the cited documents be considered and officially cited, and that a copy of the Forms PTO/SB/08A&B, initialed by the Examiner to indicate that the documents have been considered, be returned to the applicants.

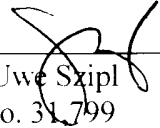
Serial No.

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It is believed that the present Information Disclosure Statement complies with the requirements of 37 C.F.R. §§ 1.97-8, but if a fee should be required, authorization is hereby given to deduct from Deposit Account No. 50-1281.

Respectfully submitted,

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